BSS138

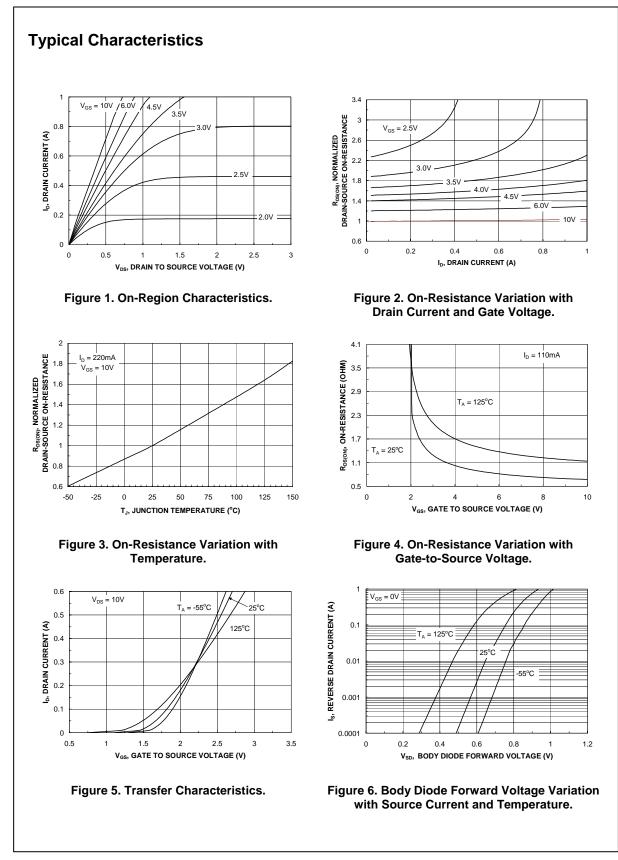
| Symbol | Parameter | Test Conditions | Min | Тур | Max | Units |
|---------------------------------------|---|---|------|-------------------|-------------------|-------|
| Off Char | acteristics | | | | 11 | |
| BV _{DSS} | Drain–Source Breakdown Voltage | $V_{GS} = 0 V$, $I_D = 250 \mu A$ | 50 | | | V |
| <u>ΔBVdss</u> ΔTj | Breakdown Voltage Temperature Coefficient | I_D = 250 µA,Referenced to 25°C | | 72 | | mV/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{\text{DS}} = 50 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$ | | | 0.5 | μA |
| | | $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V} \text{ T}_{J} = 125^{\circ}\text{C}$ | | | 5 | μA |
| | | $V_{\text{DS}} = 30 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$ | | | 100 | nA |
| I _{GSS} | Gate–Body Leakage. | $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ | | | ±100 | nA |
| On Char | acteristics (Note 2) | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{\text{DS}} = V_{\text{GS}}, \qquad I_{\text{D}} = 1 \text{ mA}$ | 0.8 | 1.3 | 1.5 | V |
| $rac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate Threshold Voltage Temperature Coefficient | $I_D = 1 \text{ mA,Referenced to } 25^{\circ}\text{C}$ | | -2 | | mV/°C |
| R _{DS(on)} | Static Drain–Source On–Resistance | $ \begin{array}{ll} V_{GS} = 10 \ V, & I_D = 0.22 \ A \\ V_{GS} = 4.5 \ V, & I_D = 0.22 \ A \\ V_{GS} = 10 \ V, \ I_D = 0.22 \ A, \ T_J = 125^\circ C \end{array} $ | | 0.7 1.0 1.1 | 3.5 6.0 5.8 | Ω |
| I _{D(on)} | On–State Drain Current | $V_{GS} = 10 \text{ V}, \qquad V_{DS} = 5 \text{ V}$ | 0.2 | | | А |
| g fs | Forward Transconductance | $V_{DS} = 10V,$ $I_{D} = 0.22 \text{ A}$ | 0.12 | 0.5 | | S |
| Dynamic | c Characteristics | | | | | |
| C _{iss} | Input Capacitance | $V_{DS} = 25 V$, $V_{GS} = 0 V$, f = 1.0 MHz | | 27 | | pF |
| Coss | Output Capacitance | | | 13 | | pF |
| C _{rss} | Reverse Transfer Capacitance | - | | 6 | | pF |
| R _G | Gate Resistance | $V_{GS} = 15 \text{ mV}, \text{ f} = 1.0 \text{ MHz}$ | | 9 | | Ω |
| Switchin | ng Characteristics (Note 2) | | | | | |
| t _{d(on)} | Turn–On Delay Time | $V_{DD} = 30 V$, $I_D = 0.29 A$, | | 2.5 | 5 | ns |
| tr | Turn–On Rise Time | $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ | | 9 | 18 | ns |
| t _{d(off)} | Turn–Off Delay Time | | | 20 | 36 | ns |
| t _f | Turn–Off Fall Time | | | 7 | 14 | ns |
| Qg | Total Gate Charge | $V_{DS} = 25 \text{ V}, \qquad I_{D} = 0.22 \text{ A},$ | | 1.7 | 2.4 | nC |
| Q _{gs} | Gate-Source Charge | V _{GS} = 10 V | | 0.1 | | nC |
| Q _{gd} | Gate-Drain Charge | - | | 0.4 | | nC |
| Drain-Se | ource Diode Characteristics | and Maximum Ratings | | | | |
| Is | Maximum Continuous Drain–Sourc | | | | 0.22 | А |
| V _{SD} | Drain–Source Diode Forward Voltage | $V_{GS} = 0 \ V, \qquad I_S = 0.44 \ A(\text{Note 2})$ | | 0.8 | 1.4 | V |

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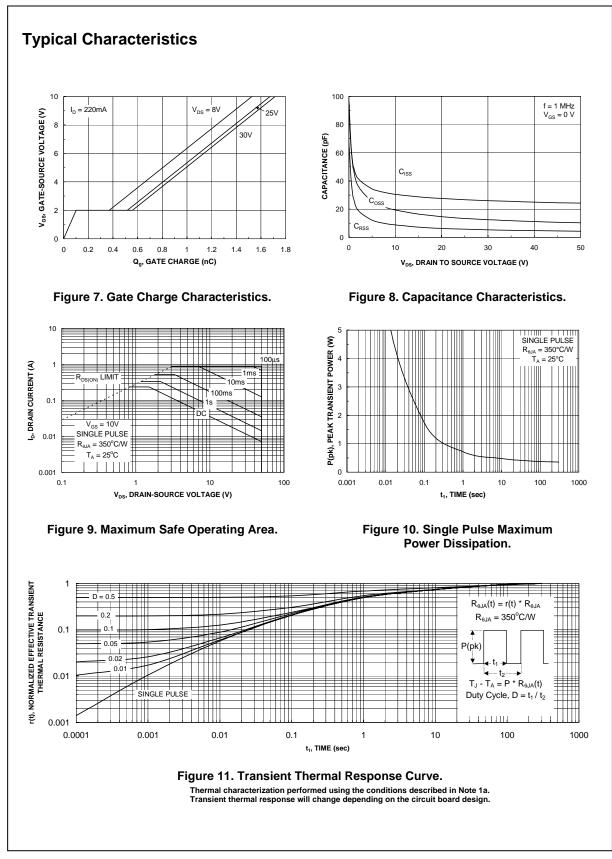
 a) 350°C/W when mounted on a minimum pad..

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%



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